

STL140N4LLF5

N-channel 40 V, 0.00275 Ω 32 A, PowerFLAT™ (5x6) STripFET™ V Power MOSFET

Preliminary data

Features

Туре	V _{DSS} R _{DS(on)} max		I _D
STL140N4LLF5	40 V	$0.00275~\Omega$	32 A ⁽¹⁾

- 1. The value is rated according $R_{thj\text{-pcb.}}$
- \blacksquare R_{DS(on)} * Q_g industry benchmark
- Extremely low on-resistance R_{DS(on)}
- High avalanche ruggedness
- Low gate drive power losses

Application

■ Switching applications

Description

The STL140N4LLF5 is an N-channel STripFET™V Power MOSFET which has been designed to achieve very low on-state resistance providing also one of the best-in-class figure of merit (FOM).

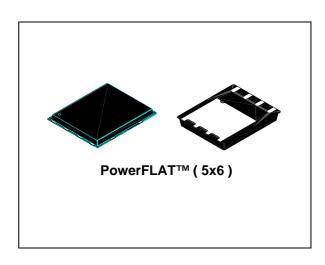


Figure 1. Internal schematic diagram

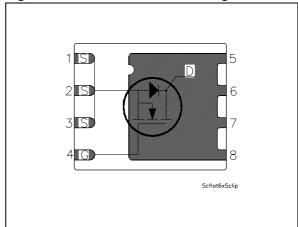


Table 1. Device summary

Order code	Marking	Package	Packaging
STL140N4LLF5	140N4LLF5	PowerFLAT™ (5x6)	Tape and reel

Contents STL140N4LLF5

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STL140N4LLF5 Electrical ratings

1 Electrical ratings

Table 2. Absolute maximum ratings

Symbol	Parameter	Value	Unit
V _{DS}	Drain-source voltage (V _{GS} = 0)	40	V
V _{GS}	Gate-source voltage	± 22	٧
I _D ⁽¹⁾	Drain current (continuous) at T _C = 25 °C	140	Α
I _D ⁽¹⁾	Drain current (continuous) at T _C = 100 °C	88	Α
I _D ⁽²⁾	Drain current (continuous) at T _C = 25 °C	32	Α
I _D ⁽³⁾	Drain current (continuous) at T _C =100 °C	20	Α
I _{DM} ⁽³⁾	Drain current (pulsed)	128	Α
P _{TOT} ⁽¹⁾	Total dissipation at T _C = 25 °C	80	W
P _{TOT} (2)	Total dissipation at T _C = 25 °C	4	W
	Derating factor	0.03	W/°C
T _J T _{stg}	Operating junction temperature Storage temperature	-55 to 150	°C

^{1.} The value is rated according $R_{\text{thj-c}}$

Table 3. Thermal resistance

Symbol	Parameter	Value	Unit
R _{thj-case}	Thermal resistance junction-case (drain) (steady state)	1.56	°C/W
R _{thj-pcb} (1)	Thermal resistance junction-ambient	31.3	°C/W

^{1.} When mounted on FR-4 board of 1inch², 2oz Cu, t < 10 sec

Table 4. Avalanche data

Symbol	Parameter	Value	Unit
I _{AV}	Not-repetitive avalanche current, (pulse width limited by Tj Max)	TBD	Α
E _{AS}	Single pulse avalanche energy (starting $T_J = 25$ °C, $I_D = I_{AV}$, $V_{DD} = 24$ V)	TBD	mJ

^{2.} The value is rated according $R_{\mbox{\scriptsize thj-pcb}}$

^{3.} Pulse width limited by safe operating area

Electrical characteristics STL140N4LLF5

2 Electrical characteristics

(T_{CASE} = 25 °C unless otherwise specified)

Table 5. On/off states

Symbol	Parameter Test conditions			Тур.	Max.	Unit
V _{(BR)DSS}	Drain-source breakdown voltage	I _D = 250 μ A, V _{GS} = 0				٧
I _{DSS}	Zero gate voltage drain current (V _{GS} = 0)	V_{DS} = Max rating, V_{DS} = Max rating @125 °C			1 10	μ Α μ Α
I _{GSS}	Gate body leakage current (V _{DS} = 0)	V _{GS} = ±22 V			±100	nA
V _{GS(th)}	Gate threshold voltage	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	1			>
R _{DS(on)}	Static drain-source on resistance	V_{GS} = 10 V, I_{D} = 16 A V_{GS} = 4.5 V, I_{D} = 16 A		0.0021 0.0024	0.00275 0.0031	Ω

Table 6. Dynamic

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
C _{iss} C _{oss} C _{rss}	Input capacitance Output capacitance Reverse transfer capacitance	V _{DS} = 25 V, f=1 MHz, V _{GS} =0	-	5900 870 130	-	pF pF pF
Q _g Q _{gs} Q _{gd}	Total gate charge Gate-source charge Gate-drain charge	V_{DD} =15 V, I_{D} = 32 A V_{GS} = 4.5 V (see Figure 3)	-	45 TBD TBD	-	nC nC nC
R _G	Gate input resistance	f=1 MHz Gate DC Bias = 0 Test signal level = 20 mV open drain	-	TBD	-	Ω

Table 7. Switching times

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
t _{d(on)} t _r t _{d(off)} t _f	Turn-on delay time Rise time Turn-off delay time Fall time	V_{DD} =15 V, I_{D} = 16 A, R_{G} =4.7 Ω , V_{GS} =10 V (see Figure 2)	-	TBD TBD TBD TBD	-	ns ns ns

Table 8. Source drain diode

Symbol	Parameter Test conditions Min T					Unit
I _{SD}	Source-drain current		-		18	Α
I _{SDM} ⁽¹⁾	Source-drain current (pulsed)		-		72	Α
V _{SD} ⁽²⁾	Forward on voltage	I _{SD} = 32 A, V _{GS} =0	-		1.1	V
t _{rr} Q _{rr} I _{RRM}	Reverse recovery time Reverse recovery charge Reverse recovery current	I_{SD} = 32 A, di/dt = 100 A/ μ s, V_{DD} = 25 V	-	TBD TBD TBD		ns nC A

^{1.} Pulse width limited by safe operating area

^{2.} Pulsed: pulse duration=300 μ s, duty cycle 1.5%

Test circuits STL140N4LLF5

3 Test circuits

Figure 2. Switching times test circuit for resistive load

Figure 3. Gate charge test circuit

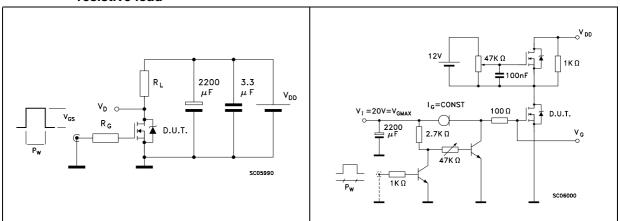


Figure 4. Test circuit for inductive load switching and diode recovery times

Figure 5. Unclamped inductive load test circuit

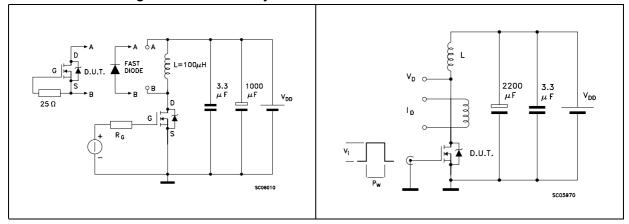
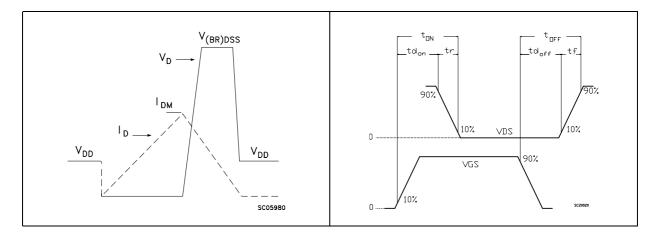


Figure 6. Unclamped inductive waveform

Figure 7. Switching time waveform



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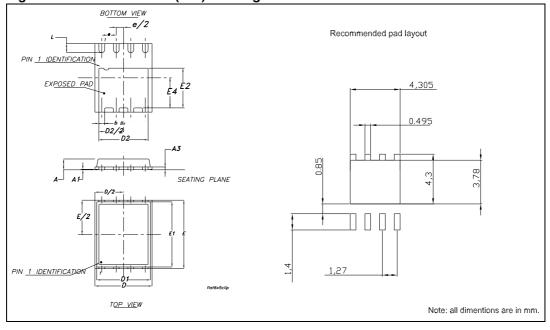
4 Package mechanical data

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Table 9. Power FLAT™ (5x6) mechanical data

		(0210) 11100				
Dim.		mm.				
Dilli.	Min.	Тур.	Max.	Min.	Тур.	Max.
Α	0.80	0.83	0.93	0.031	0.32	0.036
A1		0.02	0.05		0.0007	0.0019
A3		0.20			0.007	
b	0.35	0.40	0.47	0.013	0.015	0.018
D		5.00			0.196	
D1		4.75			0.187	
D2	4.15	4.20	4.25	0.163	0.165	0.167
Е		6.00			0.236	
E1		5.75			0.226	
E2	3.43	3.48	3.53	0.135	0.137	0.139
E4	2.58	2.63	2.68		0.103	0.105
е		1.27			0.050	
L	0.70	0.80	0.90	0.027	0.031	0.035

Figure 8. Power FLAT™ (5x6) drawing



STL140N4LLF5 Revision history

5 Revision history

Table 10. Document revision history

Date	Revision	Changes
03-Jun-2010	1	First release.

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